



#### **60V N-CHANNEL ENHANCEMENT MODE MOSFET**

#### **Product Summary**

BVDSS	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>A</sub> = +25°C
60V	6.6mΩ @ V <sub>GS</sub> = 10V	14.8A
	8.4mΩ @ V <sub>GS</sub> = 4.5V	13.1A

### **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Synchronous Rectifier
- Power Management Functions
- DC-DC Converters

## **Features and Benefits**

- 100% Unclamped Inductive Switching (UIS) Test in Production— Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low RDS(ON) Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

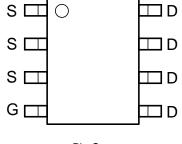
https://www.diodes.com/quality/product-definitions/

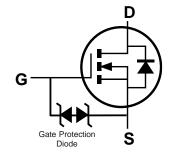
#### **Mechanical Data**

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 (§3)
- Weight: 0.074 grams (Approximate)









Top View

Pin-Out Top View

**Equivalent Circuit** 

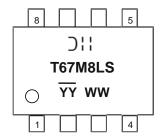
#### **Ordering Information** (Note 4)

Part Number	Case	Packaging
DMT67M8LSS-13	SO-8	2,500/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



Terms Marking Terms Marking Terms = Product Type Marking Code Type Warking Code Type Date Code Marking Ty = Year (ex: 20 = 2020)

WW = Week (01 to 53)

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#### **Maximum Ratings** (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		V <sub>DSS</sub>	60	V
Gate-Source Voltage		V <sub>GSS</sub>	±20	V
Continuous Drain Current (Note 5) VGS = 10V	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	l <sub>D</sub>	12.0 9.6	А
Continuous Drain Current (Note 6) V <sub>GS</sub> = 10V	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	l <sub>D</sub>	14.8 11.8	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	120	А	
Maximum Continuous Body Diode Forward Current (Note 6)	ls	14	А	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)		I <sub>SM</sub>	120	А
Avalanche Current, L = 0.3mH	las	23.7	А	
Avalanche Energy, L = 0.3mH		Eas	84.5	mJ

### **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25$ °C	P <sub>D</sub>	1.4	W
Thermal Resistance, Junction to Ambient (Note 5)		Reja	88	°C/W
Total Power Dissipation (Note 6)	$T_A = +25$ °C	P <sub>D</sub>	2.2	W
Thermal Resistance, Junction to Ambient (Note 6)		Reja	58	°C/W
Thermal Resistance, Junction to Case (Note 6)		Rejc	6.8	°C/W
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

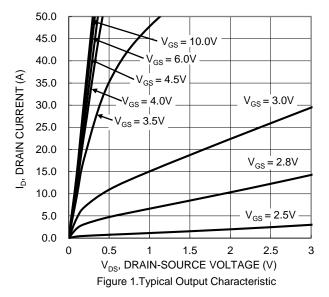
# **Electrical Characteristics** (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60	_	_	V	$V_{GS} = 0V$ , $I_D = 1mA$
Zero Gate Voltage Drain Current	IDSS	-	_	1	μΑ	V <sub>DS</sub> = 48V, V <sub>GS</sub> = 0V
Gate-Source Leakage	Igss	_	_	±10	μΑ	$V_{GS} = \pm 20V$ , $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)	<u>.</u>					•
Gate Threshold Voltage	Vgs(TH)	1.3	_	3	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$
Static Drain-Source On-Resistance	Program	_	5.1	6.6	mΩ	V <sub>G</sub> S = 10V, I <sub>D</sub> = 16.5A
Static Drain-Source On-Resistance	RDS(ON)	_	6.4	8.4	11177	V <sub>G</sub> S = 4.5V, I <sub>D</sub> = 14.5A
Diode Forward Voltage	V <sub>SD</sub>	_	0.7	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 1A
DYNAMIC CHARACTERISTICS (Note 8)	<u>.</u>					•
Input Capacitance	Ciss	_	2130	_		V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V, f = 1MHz
Output Capacitance	Coss	_	786	_	pF	
Reverse Transfer Capacitance	Crss	_	70	_		
Gate Resistance	Rg	_	0.6	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	20	_		V <sub>DS</sub> = 30V, I <sub>D</sub> = 20A
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	37.5	_	nC	
Gate-Source Charge	Q <sub>gs</sub>	_	5.4	_	liC	
Gate-Drain Charge	Qgd	_	9.5	_		
Turn-On Delay Time	t <sub>D</sub> (ON)	_	5.5	_		$V_{DD} = 30V, V_{GS} = 10V,$ $I_{D} = 20A, R_{G} = 3\Omega$
Turn-On Rise Time	t <sub>R</sub>		6.8	_	]	
Turn-Off Delay Time	tD(OFF)	_	22.1	_	ns	
Turn-Off Fall Time	tF		10.8	_		
Body Diode Reverse Recovery Time	trr		26.9	_	ns	1 000 11/14 0000 6
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>	_	56.8	_	nC	I <sub>F</sub> = 20A, di/dt = 300A/μs

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing. Notes:

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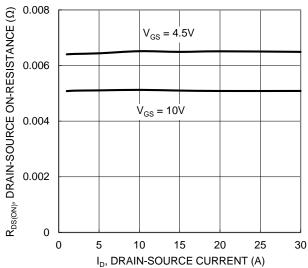


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

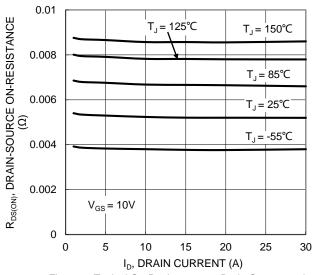


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

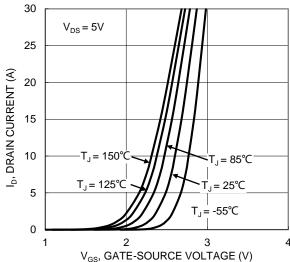


Figure 2. Typical Transfer Characteristic

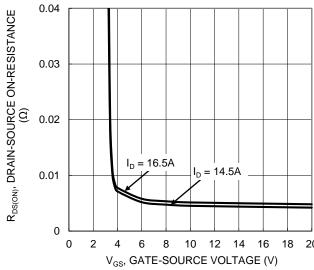


Figure 4. Typical Transfer Characteristic

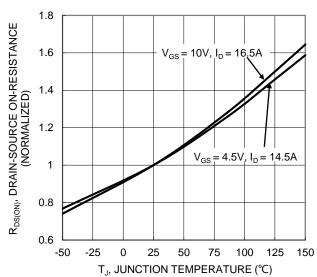


Figure 6. On-Resistance Variation with Temperature



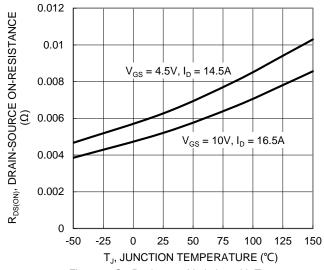
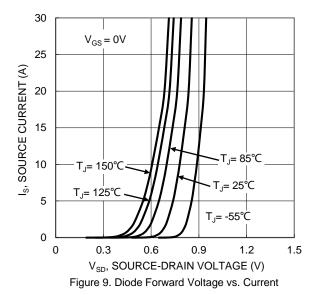
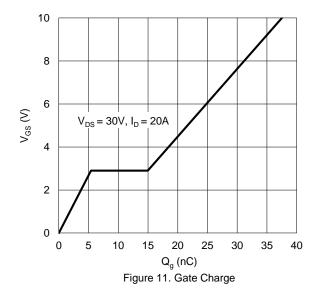


Figure 7. On-Resistance Variation with Temperature





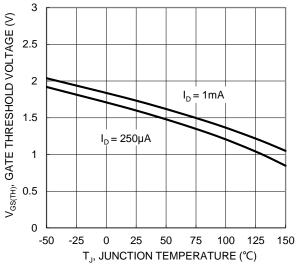
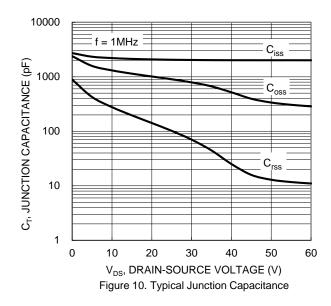
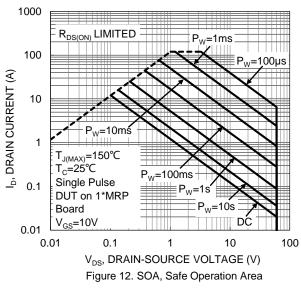


Figure 8. Gate Threshold Variation vs. Temperature







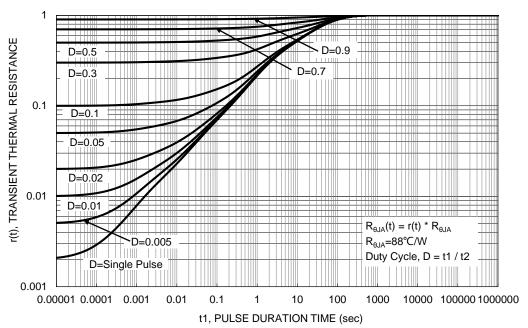


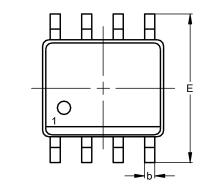
Figure 13. Transient Thermal Resistance

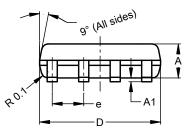


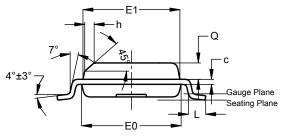
## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

**SO-8** 



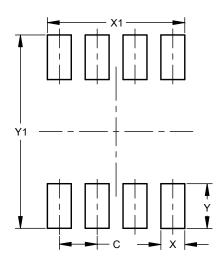




SO-8					
Dim	Min	Max	Тур		
Α	1.40	1.50	1.45		
A1	0.10	0.20	0.15		
b	0.30	0.50	0.40		
С	0.15	0.25	0.20		
D	4.85	4.95	4.90		
Е	5.90	6.10	6.00		
E1	3.80	3.90	3.85		
E0	3.85	3.95	3.90		
е	-		1.27		
h			0.35		
L	0.62	0.82	0.72		
Q	0.60	0.70	0.65		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



SO-8

Dimensions	Value (in mm)
С	1.27
Х	0.802
X1	4.612
Υ	1.505
V1	6.50



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